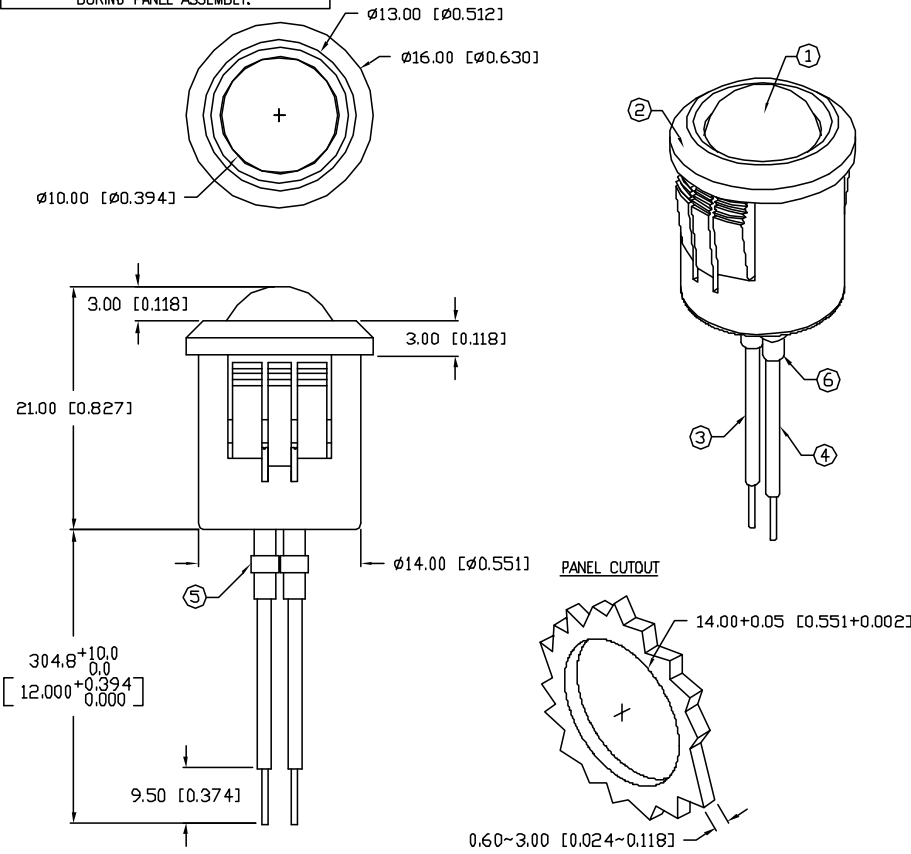


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CAUTION: PRESSURE SENSITIVE ASSEMBLY
AVOID APPLYING PRESSURE TO LED
DURING PANEL ASSEMBLY.



PART NUMBER
SSI-LXH1090ID-305

REV.

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		635		nm	
FORWARD VOLTAGE		2.0	2.5	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		40		mcad	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	$\text{mW}/^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$

* $t < 10\mu\text{s}$

NOTES:

- SSL-LX100133ID LED.
- SSH-RTF1090 HOLDER.
- ANODE LEAD: LXP-WST24RDTOC, 24 AWG STRANDED, RED INSULATION, CUT 300mm LONG, STRIP 3mm & 9.5mm.
- CATHODE LEAD: LXP-WST24BLTOC, 24 AWG STRANDED, BLACK INSULATION, CUT 300mm LONG, STRIP 3mm & 9.5mm.
- CRIMP WIRE LEADS TO LED LEADS.
- 2 PIECES- 32mm, 1/16" BLACK HEAT SHRINK TUBING.
- UV EPOXY TO RETAIN LED IN HOLDER.

UNCONTROLLED DOCUMENT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION -0.00, MAX=-DECIMAL PRECISION

REV. PART NUMBER
SSI-LXH1090ID-305

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T-10mm 635nm RED LED PANEL INDICATOR,
RED DIFFUSED LENS, 12" WIRE LEADS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: BC CHECKED BY: APPROVED BY: DATE: 1.5.02
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SCALE: N/A